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0.9-Ω SPDT ANALOG SWITCH 5-V/3.3-V SINGLE-CHANNEL 2:1 MULTIPLEXER/DEMULTIPLEXER

Check for Samples: TS5A3154

APPLICATIONS **Cell Phones**

Portable Instrumentation

Communication Circuits

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Audio and Video Signal Routing

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Wireless Terminals and Peripherals

5 D2 IN

<u>6(C2</u>

7(B2 NC

8(A2 V

NO

YZP PACKAGE

Logic

Control

0

(BOTTOM VIEW)

PDAs

Modems

GND

GND

COM

ΕN (B1)2

(D1)4

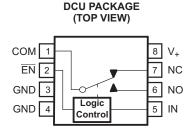
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(A1)1

Hard Drives

FEATURES

- Specified Make-Before-Break Switching
- Low ON-State Resistance (0.9 Ω)
- **Control Inputs Are 5.5-V Tolerant**
- Low Charge Injection
- Excellent ON-State Resistance Matching
- Low Total Harmonic Distortion (THD)
- 1.65-V to 5.5-V Single-Supply Operation
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
 - 2000-V Human-Body Model (A114-B, Class II)
 - 1000-V Charged-Device Model (C101)



DESCRIPTION/ORDERING INFORMATION

The TS5A3154 is a single-pole double-throw (SPDT) analog switch that is designed to operate from 1.65 V to 5.5 V. The device offers a low ON-state resistance and an excellent channel-to-channel ON-state resistance matching. The device has excellent total harmonic distortion (THD) performance and consumes very low power. These features make this device suitable for portable audio applications.

Table 1. ORDERING INFORMATIO

T _A	PACKAGE ⁽¹⁾ ⁽²⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽³⁾
–40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Reel of 3000	TS5A3154YZPR	JX_
	SSOP – DCU	Reel of 3000	TS5A3154DCUR	JCF_

(1) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.

For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI (2)website at www.ti.com.

(3)DCU: The actual top-side marking has one additional character that designates the assembly/test site. YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet. NanoFree is a trademark of Texas Instruments.





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Table 2. FUNCTION TABLE

ĒN	IN	NC TO COM, COM TO NC	NO TO COM, COM TO NO
L	L	ON	OFF
L	н	OFF	ON
н	Х	OFF	OFF

Table 3. Summary of Characteristics⁽¹⁾

Configuration	Single-Pole, Double-Throw 2:1 Multiplexer/Demultiplexer (SPDT)
Number of channels	1
ON-state resistance (r _{on})	0.9 Ω
ON-state resistance match (Δr_{on})	0.1 Ω
ON-state resistance flatness (ron(flat))	0.15 Ω
Turn-on/turn-off time (t _{ON} /t _{OFF})	8 ns/12.5 ns
Make-before-break time (t _{MBB})	12 ns
Charge injection (Q _C)	10 pC
Bandwidth (BW)	100 MHz
OFF isolation (O _{ISO})	–64 dB at 1 MHz
Crosstalk (X _{TALK})	–64 dB at 1 MHz
Total harmonic distortion (THD)	0.004%
Leakage current (I _{COM(OFF)} /I _{NC(OFF)})	±20 nA
Power-supply current (I ₊)	0.1 µA
Package option	8-pin SSOP or DSBGA

(1) $V_+ = 5 V, T_A = 25^{\circ}C$



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Absolute Minimum and Maximum Ratings^{(1) (2)}

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V+	Supply voltage range ⁽³⁾		-0.5	6.5	V
V _{NC} , V _{NO} , V _{COM}	$_{\rm D}$, Analog voltage range ^{(3) (4) (5)}		-0.5	V ₊ + 0.5	V
I _K	Analog port diode current	V_{NC} , V_{NO} , V_{COM} < 0 or V_{NO} , V_{NC} , V_{COM} > V_{+}	-50	50	mA
I _{NC} ,	On-state switch current			200	
I _{COM} , I _{NO}	On-state peak switch current ⁽⁶⁾	$V_{\rm NC}$, $V_{\rm NO}$, $V_{\rm COM}$ = 0 to V_+	-400	400	mA
VI	Digital input voltage range ^{(3) (4)}		-0.5	6.5	V
I _{IK}	Digital input clamp current	V ₁ < 0	-50		mA
I+	Continuous current through V ₊			100	mA
I _{GND}	Continuous current through GND		-100	100	mA
•	De alva da thanna di inna a da da a (7)	DCU package		227	°044
θ_{JA}	Package thermal impedance ⁽⁷⁾	YZP package		102	°C/W
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

(2) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum

(3) All voltages are with respect to ground, unless otherwise specified.

(4) The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

(5) This value is limited to 5.5 V maximum.

(6) Pulse at 1-ms duration < 10% duty cycle.

(7) The package thermal impedance is calculated in accordance with JESD 51-7.

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Electrical Characteristics for 5-V Supply⁽¹⁾

 $V_{+} = 4.5 \text{ V}$ to 5.5 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CON	DITIONS	TA	٧.	MIN	TYP	MAX	UNIT
Analog Switch	,	,		+		•			
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
Peak ON resistance	r _{peak}	$\begin{array}{l} 0 \leq (V_{NO} \text{ or } V_{NC}) \leq V_{+}, \\ I_{COM} = -100 \text{ mA}, \end{array}$	Switch ON, See Figure 13	25°C Full	4.5 V		0.9	1.1 1.3	Ω
ON-state resistance	r _{on}	V_{NO} or V_{NC} = 2.5 V, I_{COM} = -100 mA,	Switch ON, See Figure 13	25°C Full	4.5 V		0.8	0.9 1.1	Ω
ON-state resistance matching between	Δr _{on}	V_{NO} or V_{NC} = 2.5 V, I_{COM} = -100 mA,	Switch ON, See Figure 13	25°C Full	4.5 V		0.05	0.1	Ω
channels		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$	Switch ON,	25°C			0.15		
ON-state resistance flatness	r _{on(flat)}	$I_{COM} = -100 \text{ mA},$ V _{NO} or V _{NC} = 1 V, 1.5 V,	See Figure 13 Switch ON,	Full 25°C	4.5 V		0.09	0.15	Ω
liauless		2.5 V, I _{COM} = -100 mA,	See Figure 13	Full				0.15	
NC, NO OFF leakage	I _{NC(OFF)} , I _{NO(OFF)}		Switch OFF, See Figure 14	25°C Full	5.5 V	-20 -150	2	20 150	nA
current .	I _{NC(PWROFF)} , I _{NO(PWROFF)}	V_{NC} or $V_{NO} = 0$ to 5.5 V, $V_{COM} = 5.5$ V to 0,	Switch OFF, See Figure 14	25°C Full	0 V	-5 -25	0.7	5 25	μA
NC, NO ON leakage current	I _{NC(ON)} , I _{NO(ON)}	$ \begin{array}{l} V_{NC} \mbox{ or } V_{NO} = 1 \ V, \\ V_{COM} = Open, \\ \mbox{ or } \\ V_{NC} \mbox{ or } V_{NO} = 4.5 \ V, \\ V_{COM} = Open, \end{array} $	Switch ON, See Figure 15	25°C Full	5.5 V	-20 -150	2	20 150	nA
COM OFF leakage current	I _{COM(OFF)}		Switch OFF, See Figure 14	25°C Full	5.5 V	-20 -150	2	20 150	nA
	I _{COM(PWROFF)}	$\label{eq:VNC} \begin{array}{l} V_{NC} \text{ or } V_{NO} = 0 \text{ to } 5.5 \text{ V}, \\ V_{COM} = 5.5 \text{ V to } 0, \end{array}$	Switch OFF, See Figure 14	25°C Full	0 V	-5 -25	0.7	5 25	μA
COM ON leakage current	ICOM(ON)	$ \begin{array}{l} V_{COM} = 1 \ V, \\ V_{NC} \ or \ V_{NO} = Open, \\ or \\ V_{COM} = 4.5 \ V, \\ V_{NC} \ or \ V_{NO} = Open, \end{array} $	Switch ON, See Figure 15	25°C Full	5.5 V	-20 -150	2	20 150	nA
Digital Control I	nputs (IN, EN) ⁽²⁾								
Input logic high	V _{IH}			Full		2.4		5.5	V
Input logic low	V _{IL}			Full		0		0.8	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0 V		25°C Full	5.5 V	-100 -100	25	100 100	nA

(1)

The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum. All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004. (2)



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Electrical Characteristics for 5-V Supply⁽¹⁾ (continued)

 $V_{+} = 4.5 \text{ V}$ to 5.5 V, $T_{A} = -40^{\circ}\text{C}$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CON	DITIONS	TA	٧,	MIN	TYP	MAX	UNIT
Dynamic		-							
Turne and time a			0 05 - 5	25°C	5 V	1	5.2	8	
Turn- <u>on t</u> ime, IN or OE	t _{ON}		C _L = 35 pF, See Figure 17	Full	4.5 V to 5.5 V	1		9	ns
Turn-off time,			С _L = 35 рF,	25°C	5 V	5	9.5	12.5	
IN or OE	t _{OFF}		See Figure 17	Full	4.5 V to 5.5 V	4		13.5	ns
Make-before-		$V_{COM} = V_+,$	C ₁ = 35 pF,	25°C	5 V	4	6.3	12	
break time	t _{MBB}	$R_{L} = 50 \Omega,$	See Figure 18	Full	4.5 V to 5.5 V	4		13	ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 22	25°C	5 V		10		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch OFF, See Figure 16	25°C	5 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch ON, See Figure 16	25°C	5 V		57		pF
COM OFF capacitance	$C_{\text{COM(OFF)}}$	$V_{COM} = V_{+} \text{ or GND},$	Switch ON, See Figure 16	25°C	5 V		36		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_{+} \text{ or GND},$	Switch ON, See Figure 16	25°C	5 V		57		pF
Digital input capacitance	CI	$V_1 = V_+$ or GND,	See Figure 16	25°C	5 V		2		pF
Bandwidth	BW	$R_L = 50 \Omega$,	Switch ON, See Figure 19	25°C	5 V		100		MHz
OFF isolation	O _{ISO}		Switch OFF, See Figure 20	25°C	5 V		-64		dB
Crosstalk	X _{TALK}	$ \begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array} $	Switch ON, See Figure 21	25°C	5 V		-64		dB
Total harmonic distortion	THD	$R_{L} = 600 \Omega,$ $C_{L} = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 23	25°C	5 V		0.004		%
Supply				·	· · ·			·	
Positive supply current	l+	$V_I = V_+ \text{ or GND},$	Switch ON or OFF	25°C Full	5.5 V		0.02	0.1 0.5	μA

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Electrical Characteristics for 3.3-V Supply⁽¹⁾

V = 3 V to 3 6	$S V, T_A = -40^{\circ}C$ to	85°C (unloss	otherwise noted)
$v_{+} = 3 v (0 3.0$	$V, I_A = -40 \ C \ 10$		otherwise noted)

PARAMETER	SYMBOL	TEST CONDITIO	NS	TA	V+	MIN	TYP	MAX	UNIT
Analog Switch									
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
Peak ON resistance	r _{peak}	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -100 \text{ mA},$	Switch ON, See Figure 13	25°C Full	3 V		1.3	1.6 1.9	Ω
ON-state resistance	r _{on}	V_{NO} or $V_{NC} = 2 V$, $I_{COM} = -100 \text{ mA}$,	Switch ON, See Figure 13	25°C Full	3 V		1.2	1.5	Ω
ON-state			coo rigaro ro	25°C			0.08	0.15	
resistance match between channels	Δr_{on}	V_{NO} or V_{NC} = 2 V, 0.8 V I _{COM} = -100 mA,	Switch ON, See Figure 13	Full	3 V			0.15	Ω
		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$	Switch ON,	25°C			0.3		
ON-state resistance	r _{on(flat)}	$I_{COM} = -100 \text{ mA},$	See Figure 13	Full	3 V				Ω
flatness	'on(flat)	$V_{NO} \text{ or } V_{NC} = 2 \text{ V}, 0.8 \text{ V},$	Switch ON,	25°C			0.09	0.15	
		$I_{COM} = -100 \text{ mA},$	See Figure 13	Full				0.15	
NC, NO	I _{NC(OFF)} , I _{NO(OFF)}	V_{NC} or $V_{NO} = 1$ V, $V_{COM} = 3$ V, or V_{NC} or $V_{NO} = 3$ V, $V_{COM} = 1$ V,	Switch OFF, See Figure 14	25°C Full	3.6 V	-20 -50	2	20 50	nA
OFF leakage _ current	I _{NC(PWROFF)} ,	$V_{\rm NC}$ or $V_{\rm NO} = 0$ to 3.6 V,	Switch OFF,	25°C	0 V	-1	0.2	1	μA
	I _{NO(PWROFF)}	$V_{COM} = 3.6 V \text{ to } 0 V,$	See Figure 14	Full	0.	-15		15	15 ^µ
NC, NO ON leakage current	I _{NC(ON)} , I _{NO(ON)}	$ \begin{array}{l} V_{NC} \mbox{ or } V_{NO} = 1 \mbox{ V}, V_{COM} = \mbox{Open}, \\ \mbox{ or } \\ V_{NC} \mbox{ or } V_{NO} = 3 \mbox{ V}, V_{COM} = \mbox{Open}, \end{array} $	Switch ON, See Figure 15	25°C Full	3.6 V	-20 -50	2	20 50	nA
		$V_{COM} = 1 \text{ V}, \text{ V}_{NC} \text{ or } \text{ V}_{NO} = 3 \text{ V},$		25°C		-20	2	20	
COM OFF leakage	I _{COM(OFF)}	or $V_{COM} = 3 \text{ V}, V_{NC} \text{ or } V_{NO} = 1 \text{ V},$	Switch OFF, See Figure 14	Full	3.6 V	-50		50	nA
current	I	V_{NC} or $V_{NO} = 0$ to 3.6 V,	Switch OFF,	25°C	0 V	-1	0.2	1	μA
	ICOM(PWROFF)	$V_{COM} = 3.6 V \text{ to } 0,$	See Figure 14	Full	0.0	-15		15	μΑ
COM		$V_{COM} = 1 \text{ V}, V_{NC} \text{ or } V_{NO} = Open,$	Switch ON.	25°C	0.01/	-20	2	20	
ON leakage current	I _{COM(ON)}	or $V_{COM} = 3 V$, V_{NC} or $V_{NO} = Open$	See Figure 15	Full	3.6 V	-50		50	nA
Digital Control I	nputs (IN, EN) ⁽²⁾								
Input logic high	V _{IH}			Full		2		5.5	V
Input logic low	V _{IL}			Full		0		0.8	V
Input leakage	կ _H , կլ	V ₁ = 5.5 V or 0		25°C	3.6 V	-100	25	100	nA
current	ıH, ıL			Full	5.0 V	-100		100	

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(2) All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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Electrical Characteristics for 3.3-V Supply⁽¹⁾ (continued)

 V_{\star} = 3 V to 3.6 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	TIONS	TA	V+	MIN	TYP	MAX	UNIT
Dynamic									
Turn-on time,			0 25 25	25°C	3.3 V	3	6	10	
IN or OE	t _{ON}		C _L = 35 pF, See Figure 17	Full	3 V to 3.6 V	2		10.5	ns
Turn-off time,		$\mathcal{M} = \mathcal{M}$	C ₁ = 35 pF,	25°C	3.3 V	5	10	15	
IN or OE	t _{OFF}		$G_L = 35 \text{ pF},$ See Figure 17	Full	3 V to 3.6 V	4		17	ns
Make-before-				25°C	3.3 V	4	5.7	12	
break time	t _{MBB}	$V_{COM} = V_+, \\ R_L = 50 \ \Omega,$	C _L = 35 pF, See Figure 18	Full	3 V to 3.6 V	4		13	ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 22	25°C	3.3 V		9		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch OFF, See Figure 16	25°C	3.3 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch ON, See Figure 16	25°C	3.3 V		57		pF
COM OFF capacitance	C _{COM(OFF)}	$V_{COM} = V_{+} \text{ or GND},$	Switch ON, See	25°C	3.3 V		36		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_{+} \text{ or GND},$	Switch ON, See Figure 16	25°C	3.3 V		57		pF
Digital input capacitance	CI	$V_1 = V_+$ or GND,	See Figure 16	25°C	3.3 V		2		pF
Bandwidth	BW	R _L = 50 Ω,	Switch ON, See Figure 19	25°C	3.3 V		100		MHz
OFF isolation	O _{ISO}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch OFF, See Figure 20	25°C	3.3 V		-64		dB
Crosstalk	X _{TALK}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch ON, See Figure 21	25°C	3.3 V		-64		dB
Total harmonic distortion	THD	$ \begin{array}{l} R_{L} = 600 \ \Omega, \\ C_{L} = 50 \ pF, \end{array} $	f = 20 Hz to 20 kHz, See Figure 23	25°C	3.3 V		0.01 0		%
Supply									
Positive supply current	I+	$V_I = V_+$ or GND,	Switch ON or OFF	25°C Full	3.6 V		0.01	0.1 0.25	μA

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Electrical Characteristics for 2.5-V Supply⁽¹⁾

 $V_{+} = 3 V$ to 3.6 V, $T_{A} = -40^{\circ}C$ to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONE	DITIONS	TA	٧.	MIN	TYP	MAX	UNIT
Analog Switch		•		ł	•	•			
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
Peak ON resistance	r _{peak}	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -8 \text{ mA},$	Switch ON, See Figure 13	25°C Full	2.3 V		1.9	2.5 2.7	Ω
ON-state resistance	r _{on}	V_{NO} or $V_{NC} = 1.8 V$, $I_{COM} = -8 mA$,	Switch ON, See Figure 13	25°C Full	2.3 V		1.6	2.1 2.5	Ω
ON-state				25°C			0.12	0.2	
resistance matching between channels	Δr_{on}	V_{NO} or V_{NC} = 1.8 V, I_{COM} = -8 mA,	Switch ON, See Figure 13	Full	2.3 V		0.12	0.2	Ω
		$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$	Switch ON,	25°C			0.65		
ON-state resistance	r _{on(flat)}	$I_{COM} = -8 \text{ mA},$	See Figure 13	Full	2.3 V				Ω
flatness	- Un(nat)	V_{NO} or V_{NC} = 0.8 V, 1.8 V,	Switch ON,	25°C	2.0 1		0.5	1	
		$I_{COM} = -8 \text{ mA},$	See Figure 13	Full				1	
		V_{NC} or $V_{NO} = 0.5 V$,		25°C		-20	2	20	
NC, NO OFF leakage current	$\label{eq:loss} \begin{array}{c} \mbox{'NC(OFF)}, & \mbox{or} \\ \mbox{I}_{NO(OFF)} & \mbox{V}_{NC} \mbox{ or } \mbox{V}_{NO} = 2.3 \mbox{ V}, \\ \mbox{V}_{COM} = 0.5 \mbox{ V}, \end{array}$	$V_{\rm NC}$ or $V_{\rm NO}$ = 2.3 V,	Switch OFF, See Figure 14	Full	2.7 V	-50		50	nA
	I _{NC(PWROFF)} ,	V_{NC} or $V_{NO} = 0$ to 2.7 V,	Switch OFF,	25°C	0 V	-1		1	
	I _{NO(PWROFF)}		See Figure 14	Full	0 0	-10		10	μA
		V_{NC} or $V_{NO} = 0.5 V$,		25°C		-20		20	
NC, NO ON leakage current	I _{NC(ON)} , I _{NO(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = Open, \\ or \\ V_{NC} \mbox{ or } V_{NO} = 2.3 \mbox{ V}, \\ V_{COM} = Open, \end{array}$	Switch ON, See Figure 15	Full	2.7 V	-50		50	nA
		$V_{COM} = 0.5 \text{ V}, \text{ V}_{NC} \text{ or}$		25°C		-20		20	
COM OFF leakage current	I _{COM(OFF)}		Switch OFF, See Figure 14	Full	2.7 V	-50		50	nA
		V_{NC} or $V_{NO} = 0$ to 2.7 V,	Switch OFF,	25°C	0 V	-1		1	μA
	COM(PWROFF)	$V_{COM} = 2.7 V \text{ to } 0,$	See Figure 14	Full	0 0	-10		10	μΑ
		$V_{COM} = 0.5 V, V_{NC} or$		25°C		-20		20	
COM ON leakage current	I _{COM(ON)}	$\label{eq:VNO} \begin{array}{l} V_{NO} = Open, \\ or \\ V_{COM} = 2.3 \ V, \ V_{NC} \ or \\ V_{NO} = Open, \end{array}$	Switch ON, See Figure 15	Full	2.7 V	-50		50	nA
Digital Control Ir	nputs (IN, EN) ⁽²⁾							ľ	
Input logic high	V _{IH}			Full		1.8		5.5	V
Input logic low	V _{IL}			Full		0		0.6	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C Full	2.7 V	-100 -100	25	100 100	nA

(1) The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum.

(2) All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



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Electrical Characteristics for 2.5-V Supply⁽¹⁾ (continued)

 V_{\star} = 3 V to 3.6 V, T_{A} = –40°C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST CONI	DITIONS	T _A	V.	MIN	TYP	MAX	UNIT
Dynamic				•					
Turn-on time,		$\lambda = \lambda$	$C_1 = 35 pF_2$	25°C	2.5 V	4	7.0	11.5	
IN or OE	t _{ON}	$V_{COM} = V_+, \\ R_L = 50 \ \Omega,$	$O_L = 35 \text{ pr},$ See Figure 17	Full	2.3 V to 2.7 V	3.5		12	ns
Turn-off time,		$V_{COM} = V_+,$	C _L = 35 pF,	25°C	2.5 V	5	11.5	18.5	
IN or OE	t _{OFF}	$R_{L} = 50 \Omega,$	See Figure 17	Full	2.3 V to 2.7 V	4		21	ns
Make-before-		$V_{COM} = V_+,$	$C_1 = 35 pF_2$	25°C	2.5 V	4	6.3	15	
break time	t _{MBB}	$R_{L} = 50 \Omega,$	See Figure 18	Full	2.3 V to 2.7 V	4		16	ns
Charge injection	Q _C	$V_{GEN} = 0,$ $R_{GEN} = 0,$	C _L = 1 nF, See Figure 22	25°C	2.5 V		7		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch OFF, See Figure 16	25°C	2.5 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch ON, See Figure 16	25°C	2.5 V		57		pF
COM OFF capacitance	C _{COM(OFF)}	$V_{COM} = V_+ \text{ or GND},$	Switch ON, See Figure 16	25°C	2.5 V		36		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_+ \text{ or GND},$	Switch ON, See Figure 16	25°C	2.5 V		57		pF
Digital input capacitance	Cl	$V_{I} = V_{+}$ or GND,	See Figure 16	25°C	2.5 V		2		pF
Bandwidth	BW	R _L = 50 Ω,	Switch ON, See Figure 19	25°C	2.5 V		100		MHz
OFF isolation	O _{ISO}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch OFF, See Figure 20	25°C	2.5 V		-64		dB
Crosstalk	X _{TALK}	$\begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array}$	Switch ON, See Figure 21	25°C	2.5 V		-64		dB
Total harmonic distortion	THD	$R_L = 600 \Omega,$ $C_L = 50 pF,$	f = 20 Hz to 20 kHz, See Figure 23	25°C	2.5 V		0.020		%
Supply									
Positive supply current	I+	$V_{I} = V_{+}$ or GND,	Switch ON or OFF	25°C Full	2.7 V		0.001	0.05 0.15	μA

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Electrical Characteristics for 1.8-V Supply⁽¹⁾

PARAMETER	SYMBOL	TEST COND	ITIONS	TA	V.	MIN	TYP	MAX	UNIT
Analog Switch					•				
Analog signal range	V _{COM} , V _{NO} , V _{NC}					0		V+	V
Peak ON resistance	r _{peak}	$0 \le (V_{NO} \text{ or } V_{NC}) \le V_+,$ $I_{COM} = -2 \text{ mA},$	Switch ON, See Figure 13	25°C Full	1.65 V		5.5	25 30	Ω
ON-state resistance	r _{on}	V_{NO} or V_{NC} = 1.5 V, I_{COM} = -2 mA,	Switch ON, See Figure 13	25°C Full	1.65 V		2	2.7 3.1	Ω
ON-state resistance				25°C			0.16	0.3	
matching between channels	Δr_{on}	V_{NO} or V_{NC} = 1.5 V, I_{COM} = -2 mA,	Switch ON, See Figure 13	Full	1.65 V			0.3	Ω
ON-state		$\begin{array}{l} 0 \leq (V_{NO} \text{ or } V_{NC}) \leq V_{+}, \\ I_{COM} = -2 \text{ mA}, \end{array}$	Switch ON, See Figure 13	25°C			3		_
resistance flatness	r _{on(flat)}	V_{NO} or V_{NC} = 0.6 V, 1.5 V, I_{COM} = -2 mA,	Switch ON, See Figure 13	25°C Full	1.65 V		3	20 25	Ω
		$V_{\rm NC}$ or $V_{\rm NO}$ = 0.3 V,	Ŭ	25°C		-20	1.5	20	
NC, NO OFF leakage current	I _{NC(OFF)} , I _{NO(OFF)}		Switch OFF, See Figure 14	Full	1.95 V	-50		50	nA
current	I _{NC(PWROFF)} ,	V_{NC} or $V_{NO} = 0$ to 1.95 V,		25°C	0 V	-1	0.1	1	A
	I _{NO(PWROFF)}	$V_{COM} = 1.95 V \text{ to } 0,$		Full	0.0	-10		10	μA
		V_{NC} or $V_{NO} = 0.3 V$,		25°C		-20	1.5	20	
NC, NO ON leakage current	I _{NC(ON)} , I _{NO(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = Open, \\ or \\ V_{NC} \mbox{ or } V_{NO} = 1.65 \mbox{ V}, \\ V_{COM} = Open, \end{array}$	Switch ON, See Figure 15	Full	1.95 V	-50		50	nA
		V_{NC} or V_{NO} = 1.65 V,		25°C		-20	1.5	20	
COM OFF leakage current	I _{COM(OFF)}		Switch OFF, See Figure 14	Full	1.95 V	-50		50	nA
ourroint	1	V_{NC} or V_{NO} = 1.95 V to 0,	Switch OFF,	25°C	0 V	-1	0.06	1	
	I _{COM} (PWROFF)	$V_{COM} = 0$ to 1.95 V,	See Figure 14	Full	0 0	-10		10	μA
0014		V_{NC} or V_{NO} = Open,		25°C		-20	1.5	20	
COM ON leakage current	I _{COM(ON)}	$\label{eq:VCOM} \begin{array}{l} V_{COM} = 0.3 \ V, \\ \text{or} \\ V_{NC} \ \text{or} \ V_{NO} = \text{Open}, \\ V_{COM} = 1.65 \ V, \end{array}$	Switch ON, See Figure 15	Full	1.95 V	-50		50	nA
Digital Control	Inputs (IN, EN) ⁽²⁾)				1			
Input logic high	V _{IH}			Full		1.5		5.6	V
Input logic low	V _{IL}			Full		0		0.6	V
Input leakage current	I _{IH} , I _{IL}	V _I = 5.5 V or 0		25°C Full	1.95 V	-100 -100	25	100 100	nA

The algebraic convention, whereby the most negative value is a minimum and the most positive value is a maximum All unused digital inputs of the device must be held at V₊ or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004. (1) (2)



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Electrical Characteristics for 1.8-V Supply⁽¹⁾ (continued)

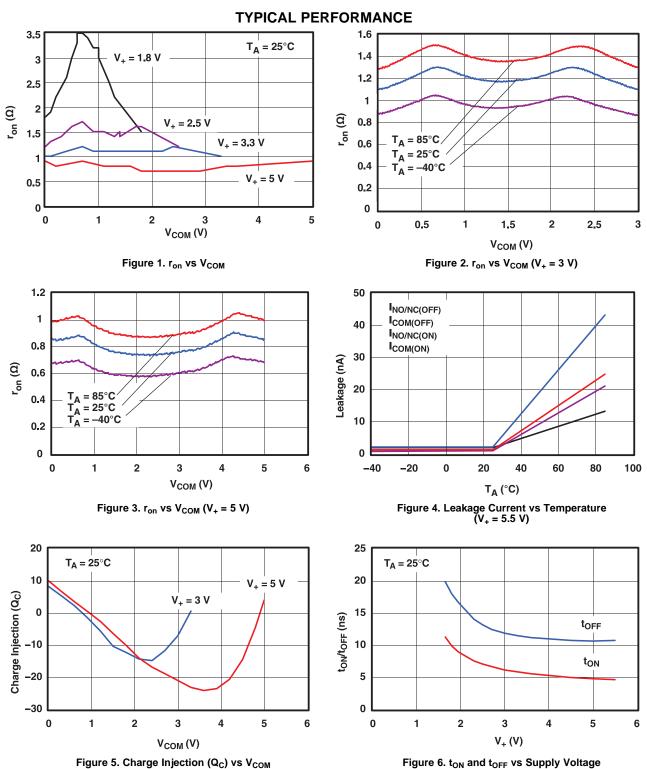
 $V_{+} = 1.65$ V to 1.95 V, $T_{A} = -40^{\circ}$ C to 85°C (unless otherwise noted)

PARAMETER	SYMBOL	TEST COND	ITIONS	TA	V.	MIN	TYP	MAX	UNIT
Dynamic		-			• • • •				
Turne on times			0 05 - 5	25°C	5 V	5		20.5	
Turn- <u>on t</u> ime, IN or OE	t _{ON}		C _L = 35 pF, See Figure 17	Full	1.65 V to 1.95 V	4.5		21	ns
Turn-off time,			C ₁ = 35 pF,	25°C	5 V	7	16.5	27.5	
IN or OE	t _{OFF}	$V_{COM} = V_{+},$ R _L = 50 Ω,	$G_L = 35 \text{ pr},$ See Figure 17	Full	1.65 V to 1.95 V	5		30	ns
Maka hafara			0 25 25	25°C	5 V	4	8.3	15	
Make-before- break time	t _{MBB}	$V_{COM} = V_+, \\ R_L = 50 \ \Omega,$	C _L = 35 pF, See Figure 18	Full	1.65 V to 1.95 V	4		16	ns
Charge injection	Q _C		C _L = 1 nF, See <mark>Figure 22</mark>	25°C	1.8 V		5		рС
NC, NO OFF capacitance	$\begin{array}{c} C_{NC(OFF)},\\ C_{NO(OFF)} \end{array}$	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch OFF, See Figure 16	25°C	1.8 V		19		pF
NC, NO ON capacitance	C _{NC(ON)} , C _{NO(ON)}	V_{NC} or $V_{NO} = V_{+}$ or GND,	Switch ON, See Figure 16	25°C	1.8 V		57		pF
COM OFF capacitance	C _{COM(OFF)}	$V_{COM} = V_+ \text{ or GND},$	Switch ON, See Figure 16	25°C	1.8 V		36		pF
COM ON capacitance	C _{COM(ON)}	$V_{COM} = V_+ \text{ or } GND,$	Switch ON, See <mark>Figure 16</mark>	25°C	1.8 V		57		pF
Digital input capacitance	CI	$V_{I} = V_{+}$ or GND,	See Figure 16	25°C	1.8 V		2.0		pF
Bandwidth	BW	$R_L = 50 \Omega$,	Switch ON, See Figure 19	25°C	1.8 V		100		MHz
OFF isolation	O _{ISO}	$ \begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array} $	Switch OFF, See Figure 20	25°C	1.8 V		-64		dB
Crosstalk	X _{TALK}	$ \begin{array}{l} R_{L} = 50 \ \Omega, \\ f = 1 \ MHz, \end{array} $	Switch ON, See Figure 21	25°C	1.8 V		-64		dB
Total harmonic distortion	THD		f = 20 Hz to 20 kHz, See Figure 23	25°C	1.8 V		0.060		%
Supply									
Positive supply current	I+	$V_I = V_+ \text{ or } GND,$	Switch ON or OFF	25°C Full	1.95 V		0.001	0.05 0.1	μA





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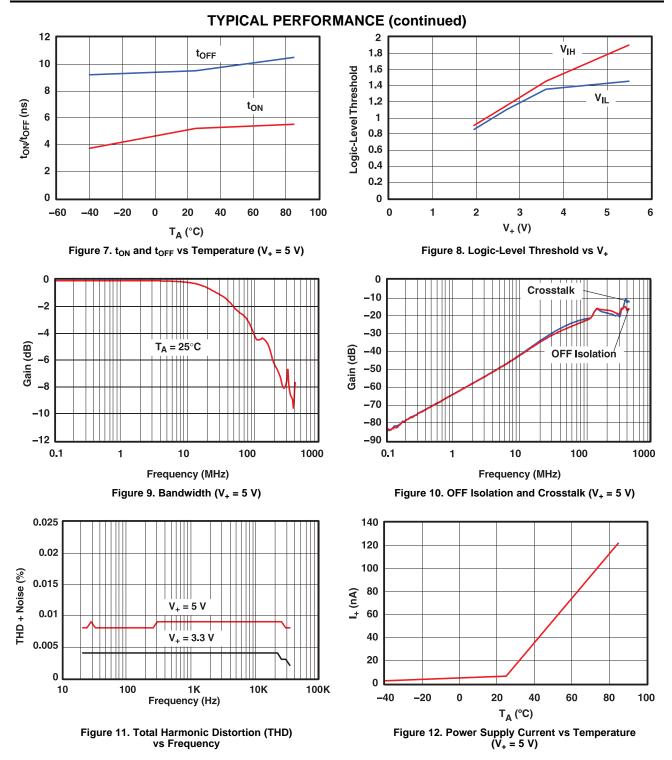




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PIN	DESCRIPTION	

PIN NO.	NAME	DESCRIPTION
1	COM	Common
2	EN	Enable control input
3	GND	Digital ground
4	GND	Digital ground
5	IN	Digital control to connect the COM to NO or NC
6	NO	Normally open
7	NC	Normally closed
8	V ₊	Power supply

PARAMETER DESCRIPTION

SYMBOL	DESCRIPTION
V _{COM}	Voltage at COM
V _{NC}	Voltage at NC
V _{NO}	Voltage at NO
r _{on}	Resistance between COM and NC or COM and NO ports when the channel is ON
Δr _{on}	Difference of r _{on} between channels in a specific device
r _{on(flat)}	Difference between the maximum and minimum value of ron in a channel over the specified range of conditions
I _{NC(OFF)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the OFF state
I _{NO(OFF)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the OFF state
I _{NC(ON)}	Leakage current measured at the NC port, with the corresponding channel (NC to COM) in the ON state and the output (COM) open
I _{NO(ON)}	Leakage current measured at the NO port, with the corresponding channel (NO to COM) in the ON state and the output (COM) open
I _{COM(ON)}	Leakage current measured at the COM port, with the corresponding channel (COM to NO or COM to NC) in the ON state and the output (NC or NO) open
V _{IH}	Minimum input voltage for logic high for the control input (IN)
V _{IL}	Maximum input voltage for logic low for the control input (IN)
VI	Voltage at the control input (IN)
I _{IH} , I _{IL}	Leakage current measured at the control input (IN)
t _{ON}	Turn-on time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning ON.
t _{OFF}	Turn-off time for the switch. This parameter is measured under the specified range of conditions and by the propagation delay between the digital control (IN) signal and analog output (COM, NC, or NO) signal when the switch is turning OFF.
t _{BBM}	Break-before-make time. This parameter is measured under the specified range of conditions and by the propagation delay between the output of two adjacent analog channels (NC and NO) when the control signal changes state.
Q _C	Charge injection is a measurement of unwanted signal coupling from the control (IN) input to the analog (NC, NO, or COM) output. This is measured in coulomb (C) and measured by the total charge induced due to switching of the control input. Charge injection, $Q_C = C_L \times \Delta V_{COM}$, C_L is the load capacitance and ΔV_{COM} is the change in analog output voltage.
C _{NC(OFF)}	Capacitance at the NC port when the corresponding channel (NC to COM) is OFF
$C_{NO(OFF)}$	Capacitance at the NO port when the corresponding channel (NO to COM) is OFF
C _{NC(ON)}	Capacitance at the NC port when the corresponding channel (NC to COM) is ON
C _{NO(ON)}	Capacitance at the NO port when the corresponding channel (NO to COM) is ON
C _{COM(ON)}	Capacitance at the COM port when the corresponding channel (COM to NC or COM to NO) is ON
CI	Capacitance of control input (IN)
O _{ISO}	OFF isolation of the switch is a measurement of OFF-state switch impedance. This is measured in dB in a specific frequency, with the corresponding channel (NC to COM or NO to COM) in the OFF state.
X _{TALK}	Crosstalk is a measurement of unwanted signal coupling from an ON channel to an OFF channel (NC to NO or NO to NC). This is measured in a specific frequency and in dB.
BW	Bandwidth of the switch. This is the frequency where the gain of an ON channel is -3 dB below the DC gain.
THD	Total harmonic distortion describes the signal distortion caused by the analog switch. This is defined as the ratio of root mean square (RMS) value of the second, third, and higher harmonic to the absolute magnitude of fundamental harmonic.

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PARAMETER DESCRIPTION (continued)

	\dot{i}
SYMBOL	DESCRIPTION
I+	Static power-supply current with the control (IN) pin at V ₊ or GND

PARAMETER MEASUREMENT INFORMATION

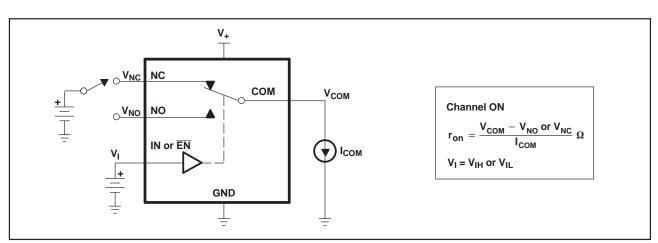


Figure 13. ON-State Resistance (ron)

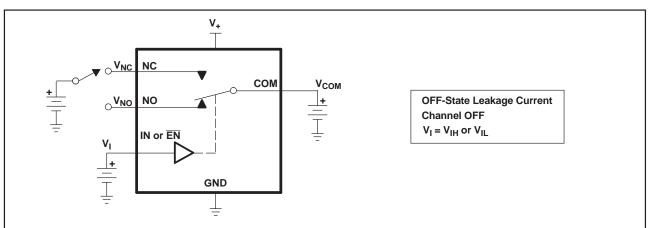


Figure 14. OFF-State Leakage Current (I_{NC(OFF)}, I_{NO(OFF)}, I_{NO(PWROFF)}, I_{COM(PWROFF)})



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PARAMETER MEASUREMENT INFORMATION (continued)

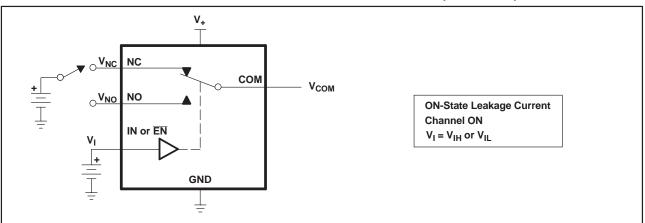


Figure 15. ON-State Leakage Current (I_{COM(ON)}, I_{NC(ON)}, I_{NO(ON)})

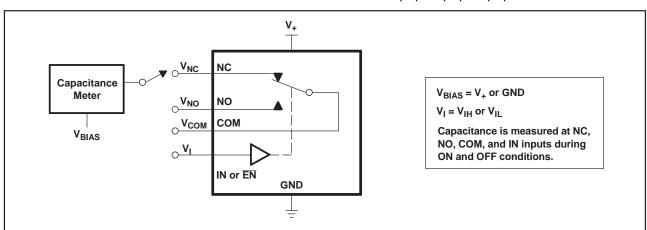
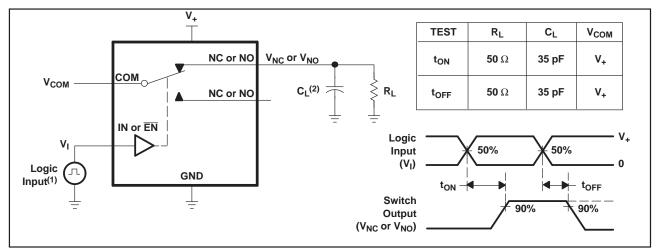


Figure 16. Capacitance (C_I, C_{COM(OFF)}, C_{COM(ON)}, C_{NC(OFF)}, C_{NO(OFF)}, C_{NC(ON)}, C_{NO(ON)})



⁽¹⁾ All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_f < 5 ns, t_f < 5 ns.

 $^{(2)}$ C_L includes probe and jig capacitance.

Figure 17. Turn-On (t_{ON}) and Turn-Off Time (t_{OFF})

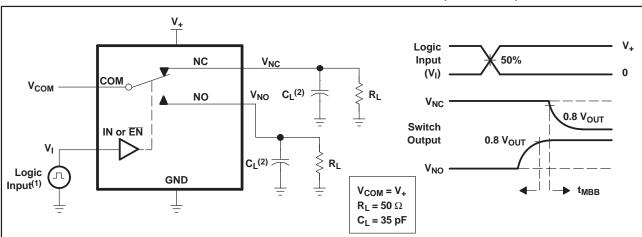


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⁽¹⁾ All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r < 5 ns, t_f < 5 ns. ⁽²⁾ C_L includes probe and jig capacitance.



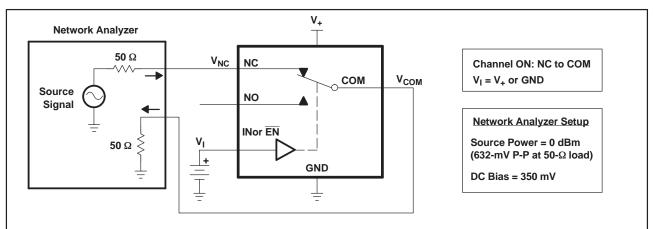


Figure 19. Bandwidth (BW)

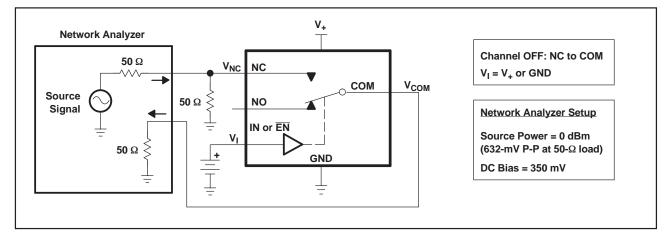


Figure 20. OFF Isolation (O_{ISO})



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PARAMETER MEASUREMENT INFORMATION (continued)

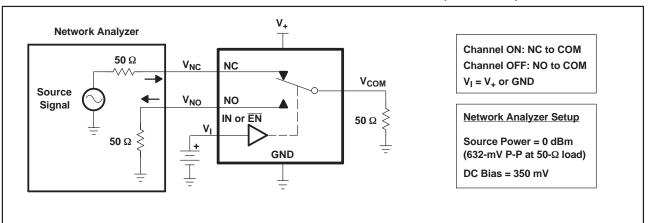
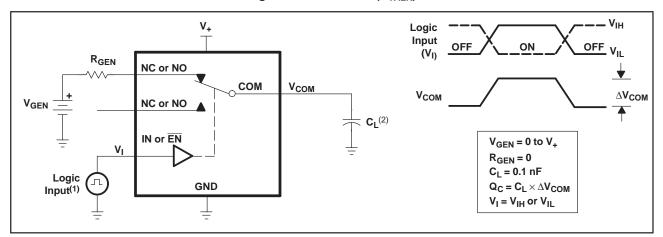


Figure 21. Crosstalk (X_{TALK})



⁽¹⁾ All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r < 5 ns, t_f < 5 ns. ⁽²⁾ C_L includes probe and jig capacitance.

Figure 22. Charge Injection (Q_C)

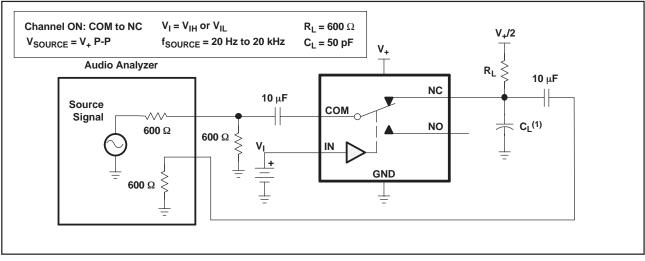


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PARAMETER MEASUREMENT INFORMATION (continued)



 $^{(1)}$ C_L includes probe and jig capacitance.

Figure 23. Total Harmonic Distortion (THD)





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REVISION HISTORY

Changes	from	Revision	в	(May	2009	to	Revision	С
Changes	nom	1164131011		lina	y ∠ 003)	, 10	1164131011	0

Changed ORDERING INFORMATION Table. 1



17-Aug-2015

PACKAGING INFORMATION

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Orderable Device	Status	Package Type	•	Pins	•	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking	Samples
	(1)		Drawing		Qty	(2)	(6)	(3)		(4/5)	
TS5A3154DCUR	ACTIVE	VSSOP	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	(CF ~ JCFR) JZ	Samples
TS5A3154DCURE6	PREVIEW	VSSOP	DCU	8	3000	TBD	Call TI	Call TI	-40 to 85	CF JZ	
TS5A3154DCURG4	ACTIVE	VSSOP	DCU	8	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 85	JCFR	Samples
TS5A3154YZPR	ACTIVE	DSBGA	YZP	8	3000	Green (RoHS & no Sb/Br)	SNAGCU	Level-1-260C-UNLIM	-40 to 85	(JX7 ~ JXN)	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. PREVIEW: Device has been announced but is not in production. Samples may or may not be available. OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined. Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above. Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

Addendum-Page 1



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PACKAGE OPTION ADDENDUM

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Addendum-Page 2



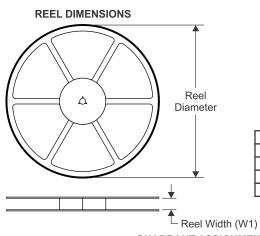


PACKAGE MATERIALS INFORMATION

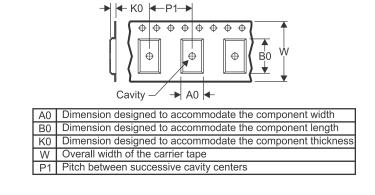
19-Aug-2015

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TAPE AND REEL INFORMATION

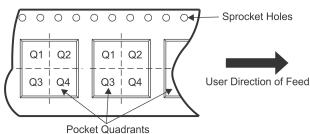


*All dimensions are nominal



TAPE DIMENSIONS

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
	TS5A3154DCUR	VSSOP	DCU	8	3000	180.0	8.4	2.25	3.35	1.05	4.0	8.0	Q3
Γ	TS5A3154DCURG4	VSSOP	DCU	8	3000	180.0	8.4	2.25	3.35	1.05	4.0	8.0	Q3
Γ	TS5A3154YZPR	DSBGA	YZP	8	3000	178.0	9.2	1.02	2.02	0.63	4.0	8.0	Q1

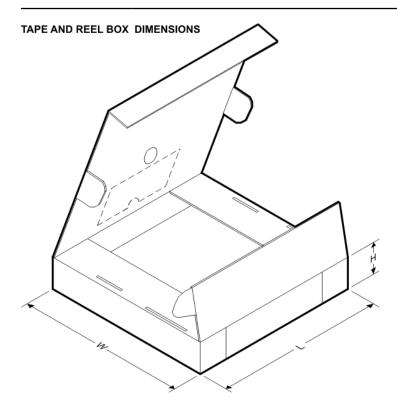


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PACKAGE MATERIALS INFORMATION

19-Aug-2015



*All dimensions are nominal

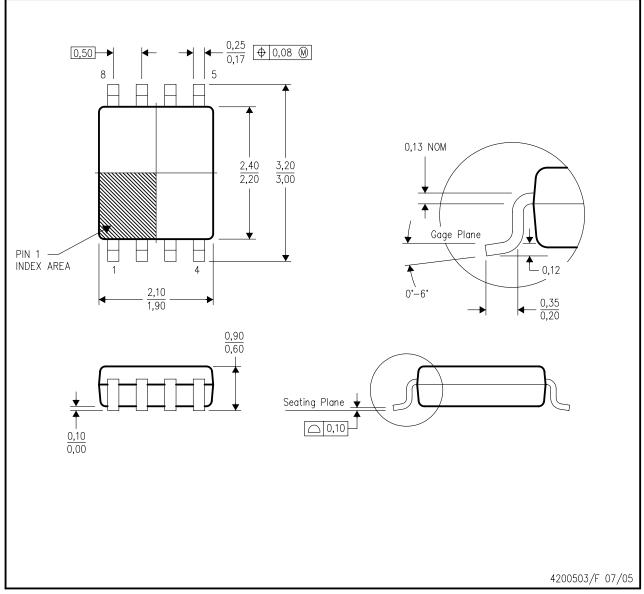
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TS5A3154DCUR	VSSOP	DCU	8	3000	202.0	201.0	28.0
TS5A3154DCURG4	VSSOP	DCU	8	3000	202.0	201.0	28.0
TS5A3154YZPR	DSBGA	YZP	8	3000	220.0	220.0	35.0



MECHANICAL DATA

DCU (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



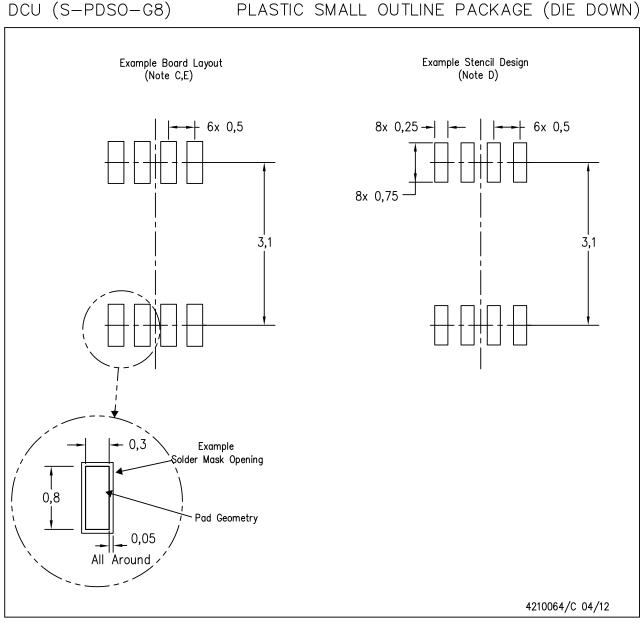
NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.





LAND PATTERN DATA



NOTES: A. All linear dimensions are in millimeters.

- This drawing is subject to change without notice. Β.
- Publication IPC-7351 is recommended for alternate designs. C.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations. E.
- Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

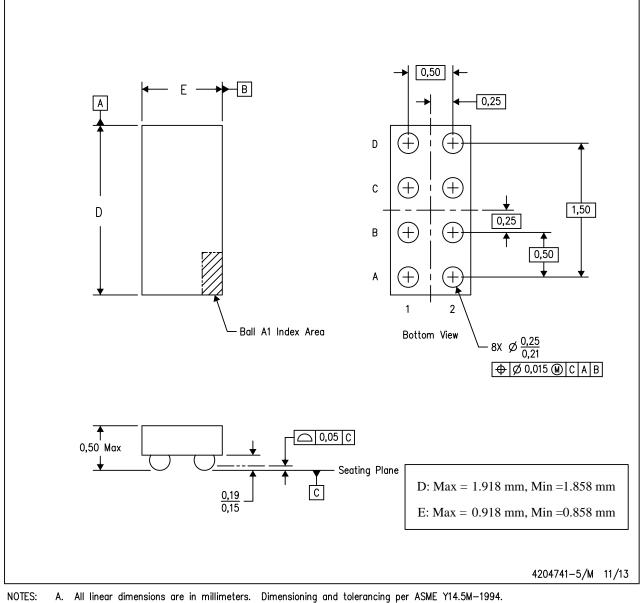




MECHANICAL DATA

YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



B. This drawing is subject to change without notice.

C. NanoFree™ package configuration.

NanoFree is a trademark of Texas Instruments.





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